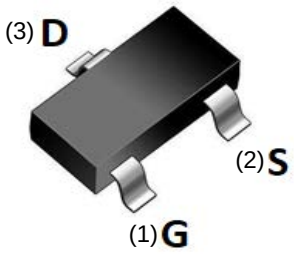
WG01P03S

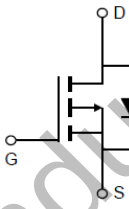
Features:

- ☐ Low Intrinsic Capacitances.
- ☐ Excellent Switching Characteristics.
- ☐ Extended Safe Operating Area.
- ☐ Unrivalled Gate Charge :Qg= 25nC (Typ.).
- ☐ BVDSS=-100V,I_D=-3A
- ☐ R_{DS}(on) : 280mΩ(Typ) @V_G=10V
- ☐ 100% Avalanche Tested

SOT-23-3L

RoHS COMPLIANT





1.Gate (G)
3.Drain (D)
2.Source (S)

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Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-100	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I_D	-3	A
Drain Current-Continuous(T_C=100℃)	I_D (100℃)	-2.1	A
Pulsed Drain Current	I_{DM}	-20	A
Maximum Power Dissipation	P_D	1.6	W
Operating Junction and Storage Temperature Range	T_J,T_{STG}	-55 To 150	℃

Thermal Characteristic

Thermal Resistance,Junction-to-Ambient (Note 2)	$R_{\theta JA}$	80	℃/W

Electrical Characteristics (T_C=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V I_D=-250μA	-100	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-100V,V_{GS}=0V	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	V_{GS}=±20V,V_{DS}=0V	-	-	±10	μA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=-250μA	-1	-1.7	-3	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=-10V, I_D=-1A	-	280	300	mΩ
		V_{GS}=-4.5V, I_D=-1A		295	310	
Forward Transconductance	g_{FS}	V_{DS}=-5V,I_D=-3A	2	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C_{lss}	V_{DS}=-25V,V_{GS}=0V, F=1.0MHz	-	760	-	PF
Output Capacitance	C_{oss}		-	260	-	PF
Reverse Transfer Capacitance	C_{rss}		-	170	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	$t_{d(on)}$	V_{DD}=-50V,I_D=-3A V_{GS}=-10V,R_{GEN}=9Ω	-	14	-	nS
Turn-on Rise Time	t_r		-	18	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	50	-	nS
Turn-Off Fall Time	t_f		-	18	-	nS
Total Gate Charge	Q_g	V_{DS}=-50V,I_D=-3A, V_{GS}=-10V	-	25	-	nC
Gate-Source Charge	Q_{gs}		-	5	-	nC
Gate-Drain Charge	Q_{gd}		-	7	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	V_{GS}=0V,I_S=-3A	-	-	-1.2	V
Diode Forward Current (Note 2)	I_S	-	-	-	-3	A
Reverse Recovery Time	t_{rr}	T_J = 25°C, I_F =-3A di/dt = 100A/μs (Note3)	-	35	-	nS
Reverse Recovery Charge	Qrr		-	46	-	nC
Forward Turn-On Time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5. E_{AS} condition：Tj=25℃,V_{DD}=-50V,V_G=-10V,L=0.5mH,Rg=25Ω

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Typical Electrical and Thermal Characteristics (Curves)

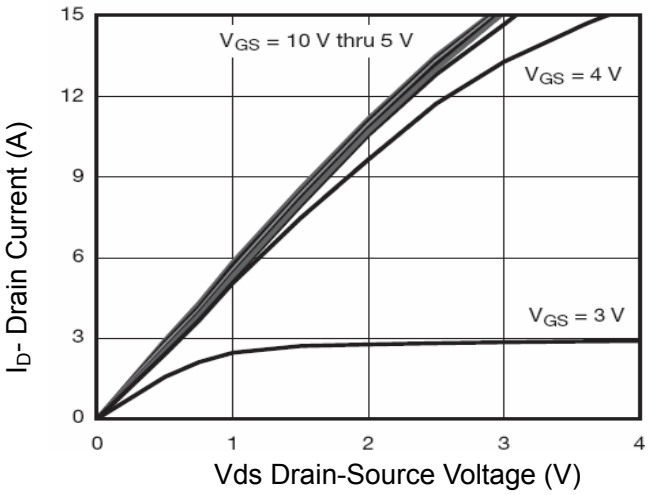


Figure 1 Output Characteristics

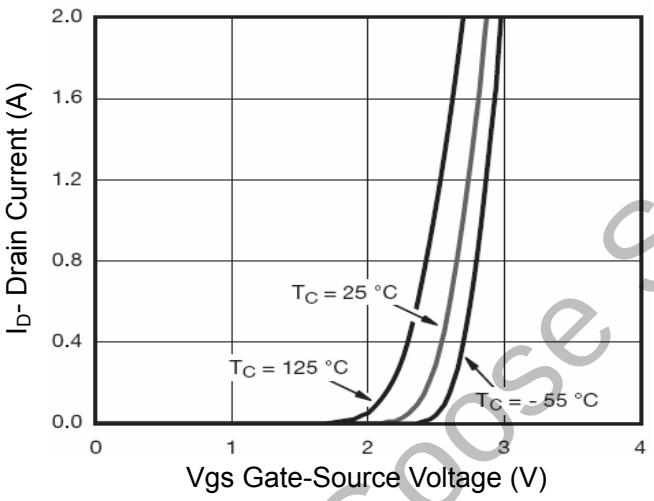


Figure 2 Transfer Characteristics

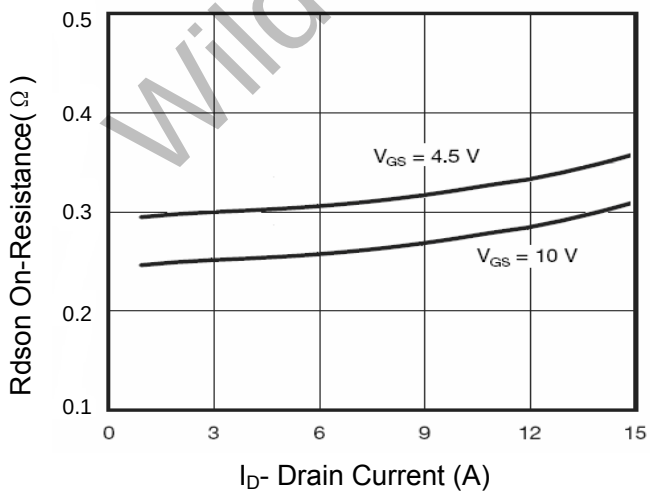


Figure 3 Rdson- Drain Current

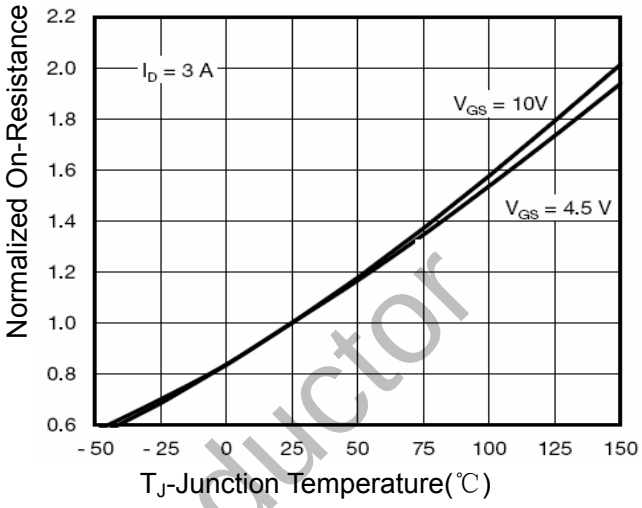


Figure 4 Rdson-JunctionTemperature

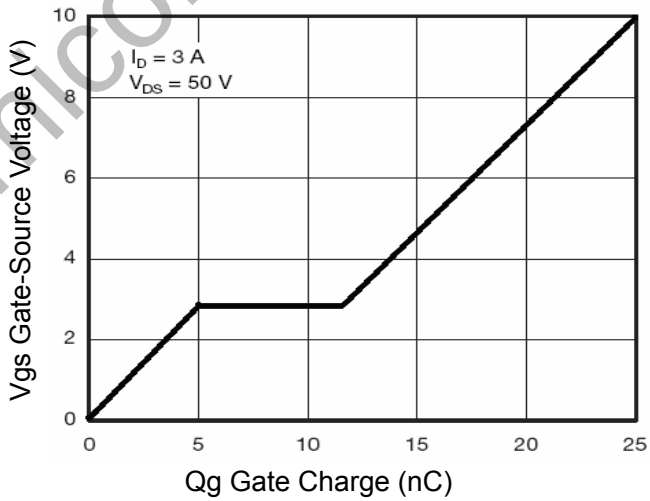


Figure 5 Gate Charge

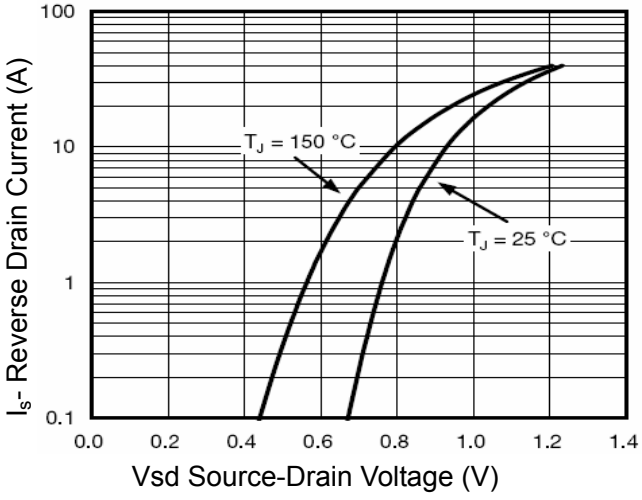


Figure 6 Source- Drain Diode Forward

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Typical Electrical and Thermal Characteristics (Curves)

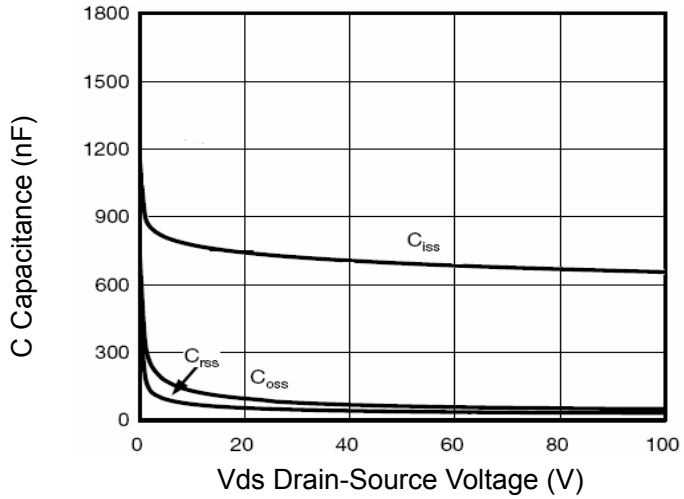


Figure 7 Capacitance vs Vds

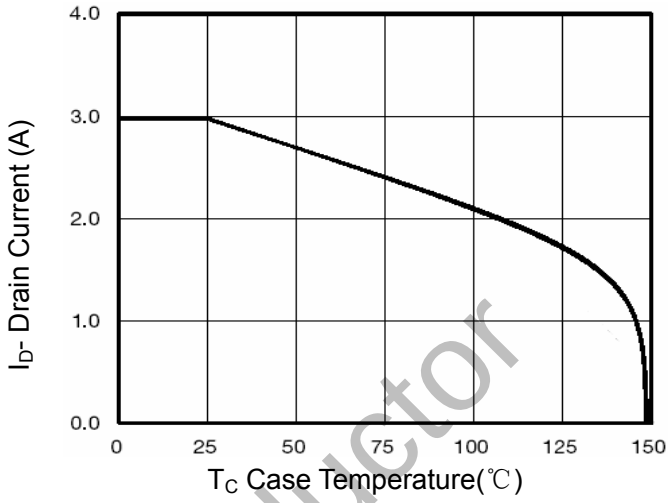


Figure 9 Drain Current vs Case Temperature

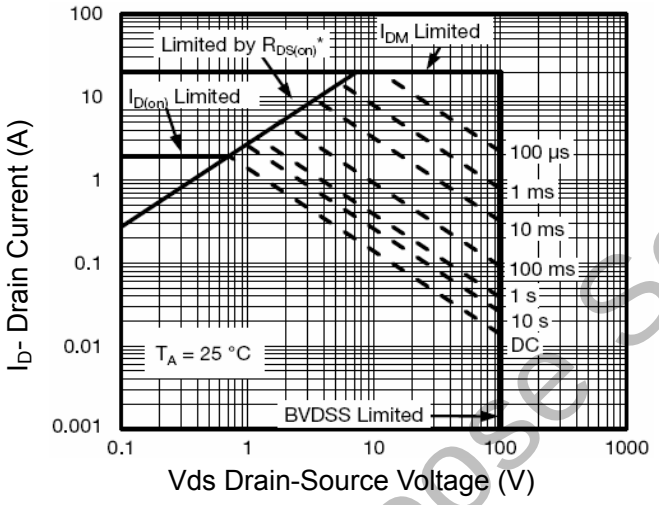


Figure 8 Safe Operation Area

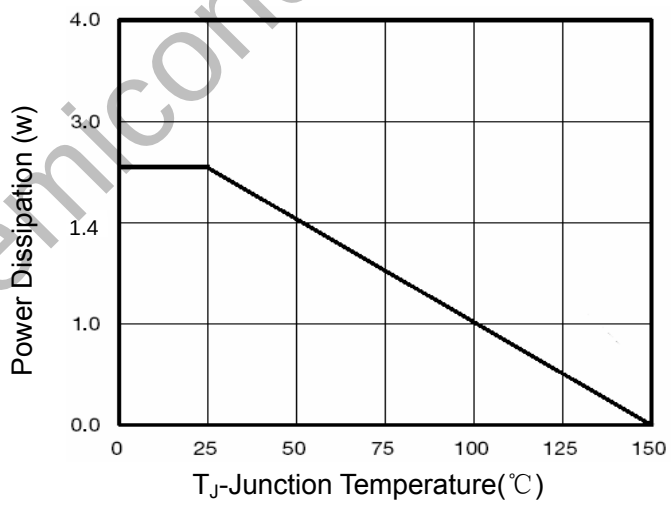


Figure 10 Power De-rating

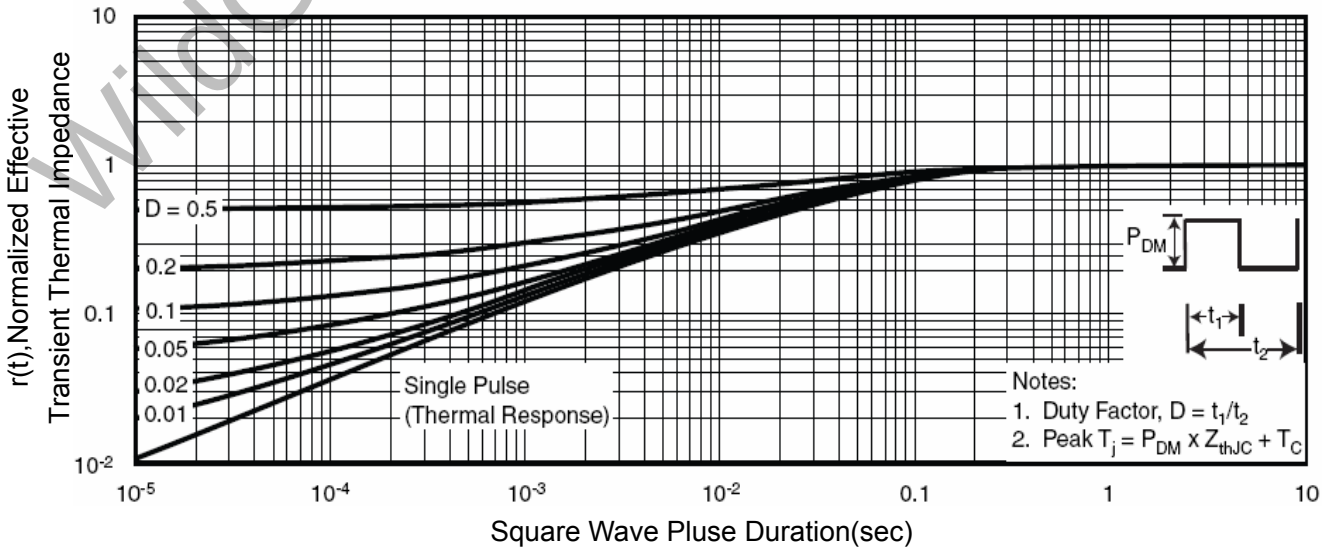
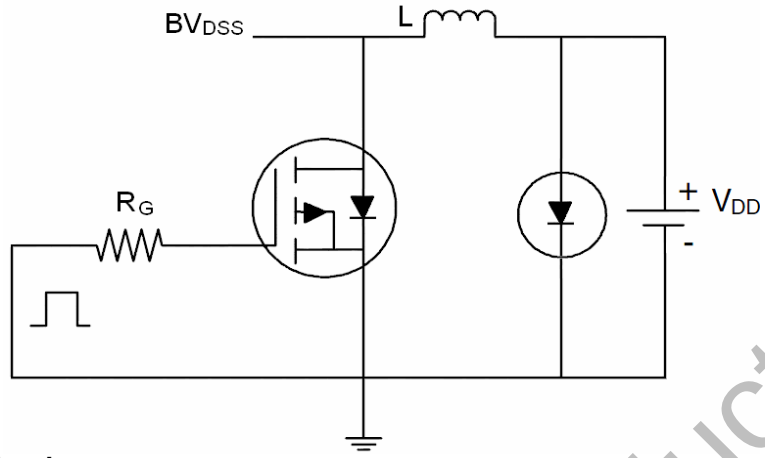


Figure 11 Normalized Maximum Transient Thermal Impedance

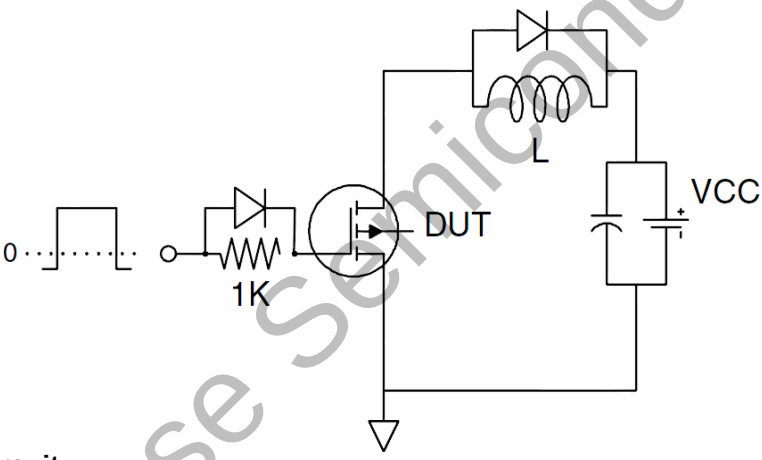
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Test Circuit

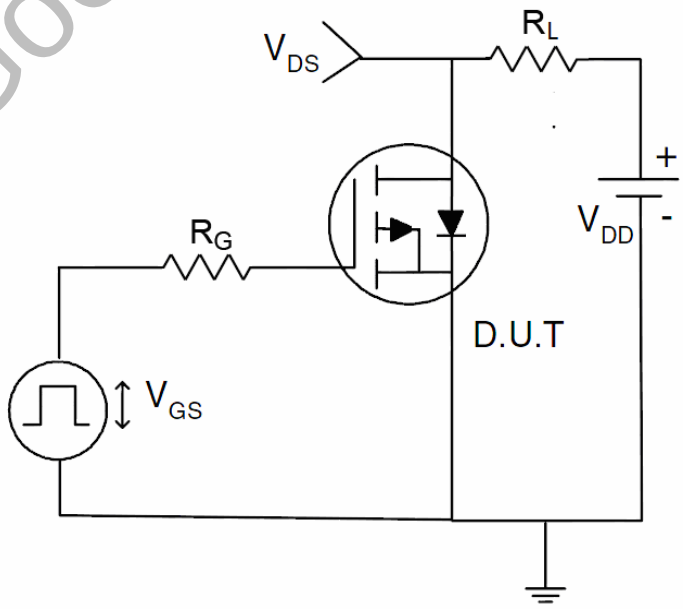
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit

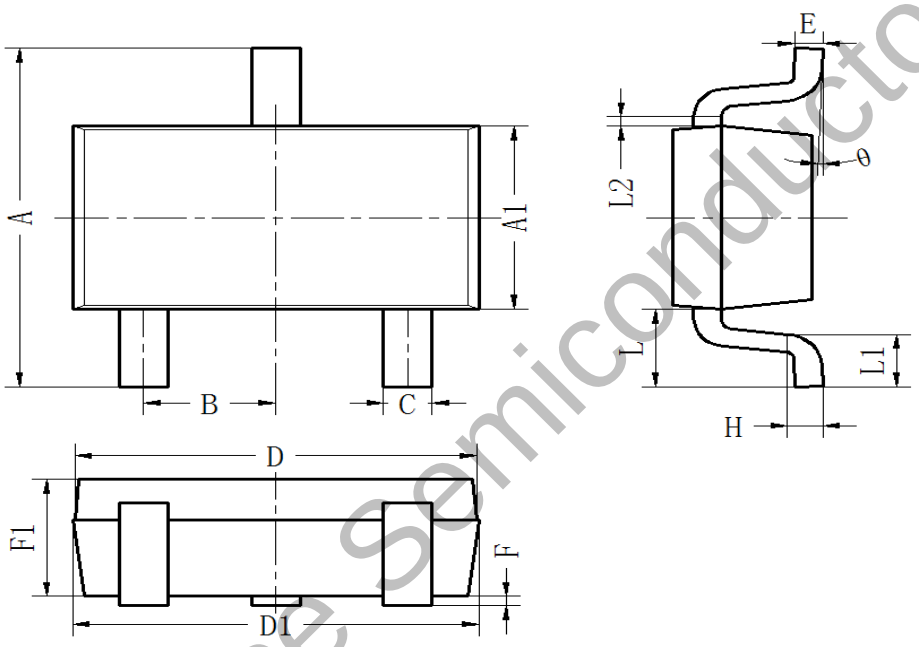


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Package Dimension

SOT-23-3L

Unit: mm



符号	标准	下公差	上公差	下限值		上限值	
				内控	放行	内控	放行
A	2.8	-0.15	0.15	2.68	2.65	2.92	2.95
A1	1.6	-0.1	0.1	1.52	1.5	1.68	1.7
B	0.95	-0.05	0.05	0.91	0.90	0.99	1.00
C	0.4	-0.1	0.1	0.32	0.3	0.45	0.5
D	2.92	-0.1	0.1	2.84	2.82	3.00	3.02
D1	2.92	-0.05	0.05	2.88	2.87	2.96	2.97
E	0.15	-0.05	0.05	0.11	0.1	0.19	0.2
H	0.254	-0.05	0.05	0.214	0.204	0.294	0.304
L	0.65	-0.1	0.1	0.57	0.55	0.73	0.75
L1	0.45	-0.15	0.15	0.33	0.3	0.57	0.6
L2	0.08	-0.02	0.02	0.06	0.06	0.10	0.10
θ	/	/	/	/	0	/	8
F1	1.1	-0.05	0.05	1.06	1.05	1.14	1.15
F	0.08	-0.04	0.04	0.05	0.04	0.11	0.12

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